NOTES:
1. Board shown from connector side.
2. Dimensions shown listing true position are basic.
3. Hole size are after plating.
4. Printed wiring board part number is 30-20101.
5. Details are for reference only.
6. Board is for reference only.
7. Solder mask must be applied over bare copper, except as noted.
8. Marking small poliide as a minimum.
9. All parts are in standard package.
10. All components or internal traces in marked areas.
11. All plated thru holes to be free of solder mask.

LAYER ASSIGNMENTS

MANUFACTURER'S NAME
 making part number
 2 oz. copper (signal - layer 1)
 2 oz. copper (ground - layer 2)
 1 oz. copper (signal - layer 3)
 1 oz. copper (signal - layer 4)
 1 oz. copper (signal - layer 5)
 2 oz. copper (signal - layer 6)

SOLDER SIDE

SOLDER MASK

COMPONENT SIDE

2 oz. copper (signal - layer 1)
2 oz. copper (ground - layer 2)
2 oz. copper (signal - layer 3)
2 oz. copper (signal - layer 4)
2 oz. copper (signal - layer 5)
2 oz. copper (signal - layer 6)